

# **Film Capacitors**

Metallized Polypropylene Film Capacitors (MKP)

**Series/Type: B32774** ... **B32778**Date: February 2017

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Metallized polypropylene film capacitors (MKP)

B32774 ... B32778

#### MKP DC link – high density series up to 480 $\mu$ F

#### **Recommended applications**

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

#### Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/105/56

#### Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

#### **Features**

- Capacitance values up to 480 uF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

#### **Terminals**

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 -1 mm

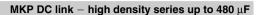
#### Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

#### **Delivery mode**

Bulk (untaped)







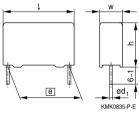
# Dimensional drawings

#### Dimensions in mm

Number of wires	Lead spacing @ ±0.4	Lead diameter d <sub>1</sub> ±0.05	Туре
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E
2-pin	37.5	1.0	B32776T
4-pin	37.5	1.2	B32776G
4-pin	37.5	1.2	B32776T
4-pin	52.5	1.2	B32778T
4-pin	52.5	1.2	B32778G
12-pin	52.5	1.2	B32778J

# **Dimensional drawings 2-pin versions**

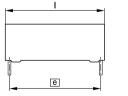
# B32774D, B32776E

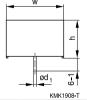


	B32774D	B32776E
Lead spacing e ±0.4:		37.5
Lead diameter d <sub>1</sub> :	0.8	1.0

(Dimensions in mm)

# B32776T (low profile)

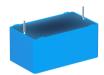




Lead spacing e ±0.4:	37.5
Lead diameter d₁:	1.0
(D) ( )	•

(Dimensions in mm)





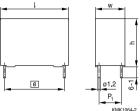




# MKP DC link – high density series up to 480 $\mu\text{F}$

## Dimensional drawings 4-pin versions

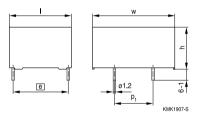
# B32776G, B32778G



776G B	007700	
7700   15	B32778G	
52	2.5	
-	1.2	
	52	

(Dimensions in mm)

## **B32776T, B32778T** (low profile)

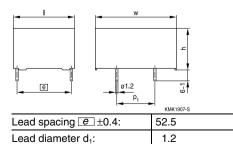


	B32776T	B32778T
Lead spacing <u>e</u> ±0.4:	37.5	52.5
Lead diameter d <sub>1</sub> :	1.2	1.2

(Dimensions in mm)

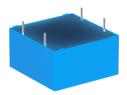
# Dimensional drawing 12-pin version

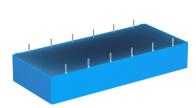
#### B32778J



(Dimensions in mm)













# Overview of available types

Lead spacing										
Туре	B3277	4			B3277	6				
Page	7				8					
V <sub>R</sub> (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C <sub>R</sub> (μF)										
1.5										
2.0										
2.7										
3.0										
3.3										
3.5										
3.9										
5.0										
6.8										
7.0										
7.5										
8.0										
8.5										
9.0										
10										
12										
13										
14										
15										
16										
20										
22										
25										
30										
35										
40										
45										
50										
60										
65										





# MKP DC link – high density series up to 480 $\mu\text{F}$

Lead spacing	52.5 mm					
Туре	B32778					
Page	11					
V <sub>R</sub> (V DC)	450	575	800	900	1100	1300
C <sub>R</sub> (μF)						
14						
20						
25						
27						
30						
35						
38						
40						
42						
45						
50						
55						
58						
60						
70						
75						
80						
90						
100						
110						
120						
130						
150						
170						
180						
200						
210						
270						
360						
480						



## MKP DC link – high density series – up to 480 $\mu$ F



# Ordering codes and packing units (lead spacing 27.5 mm)

C <sub>R</sub> <sup>1)</sup>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	$ESR_{typ}$	ESL <sub>typ</sub> <sup>3)</sup>	$tan \ \delta$	tan $\delta$	pcs.
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			MOQ
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nΗ	10-3	10 <sup>-3</sup>	
$V_{R,70}$	°C = 450 V DC, V <sub>op</sub>	<sub>85</sub> ° <sub>C</sub> =	450 V DC						
5.0	$11.0 \times 21.0 \times 31.5$	_	B32774D4505+000	5.0	21.1	19.0	1.2	10.7	2352
10.0	$15.0 \times 24.5 \times 31.5$	_	B32774D4106+000	8.0	10.9	24.0	1.2	11.0	1680
22.0	$22.0\times36.5\times31.5$	_	B32774D4226+000	14.5	5.4	30.0	1.3	12.1	784
$V_{R,70}$	$_{\text{C}}$ = 800 V DC, $V_{\text{op}}$	<sub>85</sub> ° <sub>C</sub> =	700 V DC						
3.0	$11.0 \times 21.0 \times 31.5$	_	B32774D8305+000	4.5	24.8	19.0	0.9	7.6	2352
5.0	$14.0 \times 24.5 \times 31.5$	_	B32774D8505+000	6.5	15.3	23.0	0.9	7.7	1848
12.0	$22.0 \times 36.5 \times 31.5$	_	B32774D8126+000	13.0	6.8	34.0	1.0	8.3	784
$V_{R,70}$	°C = 1100 V DC, V <sub>op</sub>	85 °C =	920 V DC						
2.0	$12.5 \times 21.5 \times 31.5$	_	B32774D0205+000	4.5	26.3	19.0	0.7	5.3	2100
3.3	$18.0 \times 27.5 \times 31.5$	_	B32774D0335+000	7.0	16.2	22.0	0.7	5.4	1428
5.0	$19.0 \times 30.0 \times 31.5$	_	B32774D0505+000	9.0	10.9	27.0	0.7	5.5	896
7.0	$22.0\times36.5\times31.5$	_	B32774D0705+000	12.0	8.1	30.0	0.7	5.8	784
$V_{R,70}$	$_{\text{C}}$ = 1300 V DC, $V_{\text{op}}$	<sub>85</sub> ℃ =	1100 V DC						
1.5	$12.5 \times 21.5 \times 31.5$	_	B32774D1155K000	4.4	31.3	20.0	0.6	4.8	2100
3.0	$18.0 \times 27.5 \times 31.5$	_	B32774D1305K000	7.0	16.0	24.0	0.6	4.9	1428
5.0	$22.0\times36.5\times31.5$	_	B32774D1505K000	10.5	9.8	33.0	0.7	5.1	784

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ 

 $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub> at 70 °C, 10 kHz for  $\Delta T \le$  20 °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)





## MKP DC link – high density series – up to 480 $\mu\text{F}$

## Ordering codes and packing units (lead spacing 37.5 mm)

$C_R^{1)}$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	$ESR_{typ}$	ESL <sub>typ</sub> <sup>3)</sup>	$tan \ \delta$	tan $\delta$	pcs.
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			MOQ
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
$\mu F$	mm	mm		Α	mΩ	nΗ	10 <sup>-3</sup>	10 <sup>-3</sup>	
$V_{R,70}$	<sub>°C</sub> = 450 V DC, V <sub>op</sub>	85 °C =	450 V DC						
12	24.0 × 15.0 × 41.5	_	B32776T4126K000	7.0	17.1	19.0	2.2	21.0	1040
16	$24.0 \times 19.0 \times 41.5$	_	B32776T4166K000	8.0	13.0	18.0	2.3	21.2	780
30	$20.0 \times 39.5 \times 41.5$	10.2	B32776G4306+000	14.0	7.0	11.0	2.3	21.3	640
30	$20.0 \times 39.5 \times 41.5$	_	B32776E4306+000	14.0	7.3	28.0	2.4	22.3	640
35	$28.0 \times 37.0 \times 42.0$	10.2	B32776G4356+000	16.5	6.0	10.0	2.3	21.4	440
35	$28.0 \times 37.0 \times 42.0$	_	B32776E4356+000	16.0	6.4	24.0	2.4	22.6	440
40	$28.0 \times 37.0 \times 42.0$	10.2	B32776G4406+000	17.5	5.3	11.0	2.3	21.4	440
40	$28.0 \times 37.0 \times 42.0$	_	B32776E4406+000	17.0	5.6	26.0	2.4	22.7	440
40	$43.0 \times 22.0 \times 41.5$	20.3	B32776T4406K000	17.0	5.2	13.0	2.3	21.2	280
50	$28.0 \times 42.5 \times 41.5$	10.2	B32776G4506+000	20.0	4.3	12.0	2.3	21.7	440
50	$28.0 \times 42.5 \times 41.5$	_	B32776E4506+000	19.0	4.7	30.0	2.5	23.8	440
60	$30.0 \times 45.0 \times 42.0$	20.3	B32776G4606+000	23.5	3.6	14.0	2.4	22.3	400
60	$30.0 \times 45.0 \times 42.0$	_	B32776E4606+000	22.0	4.0	32.0	2.5	24.2	400
65	$33.0 \times 48.0 \times 42.0$	20.3	B32776G4656+000	25.5	3.3	14.0	2.3	22.2	180
$V_{R,70}$	$_{\text{C}}$ = 575 V DC, $V_{\text{op}}$	<sub>85</sub> ℃ =	500 V DC						
8.5	$24.0 \times 15.0 \times 41.5$	_	B32776T5855+000	6.5	19.9	19.0	1.9	17.2	1040
12	$24.0 \times 19.0 \times 41.5$	_	B32776T5126K000	8.0	14.4	18.0	1.9	17.4	780
25	$20.0 \times 39.5 \times 41.5$	10.2	B32776G5256K000	14.0	7.0	12.0	1.9	17.5	640
25	$20.0 \times 39.5 \times 41.5$	_	B32776E5256K000	13.5	7.4	28.0	2.0	18.3	640
30	$28.0 \times 37.0 \times 42.0$	10.2	B32776G5306K000	16.5	5.8	11.0	1.9	17.6	440
30	$28.0 \times 37.0 \times 42.0$	_	B32776E5306K000	16.5	6.1	26.0	2.0	18.5	440
30	$43.0 \times 22.0 \times 41.5$	20.3	B32776T5306K000	16.5	5.8	13.0	1.9	17.3	280
35	$28.0 \times 42.5 \times 41.5$	10.2	B32776G5356+000	19.0	5.0	12.0	1.9	17.8	440
35	$28.0 \times 42.5 \times 41.5$	_	B32776E5356+000	18.0	5.3	29.0	2.0	19.0	440
45	$30.0 \times 45.0 \times 42.0$	20.3	B32776G5456K000	22.0	4.0	13.0	1.9	17.9	400
45	$30.0 \times 45.0 \times 42.0$	-	B32776E5456K000	21.0	4.4	32.0	2.1	19.7	400
50	$33.0\times48.0\times42.0$	20.3	B32776G5506K000	25.0	3.5	14.0	2.0	18.1	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

## Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$  $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I\_{RMS} at 70 °C, 10 kHz for  $\Delta T \le$  20 °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



## MKP DC link – high density series – up to 480 $\mu\text{F}$



## Ordering codes and packing units (lead spacing 37.5 mm)

C <sub>R</sub> <sup>1)</sup>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	$ESR_{typ}$	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	pcs.
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			MOQ
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
μF	mm	mm		Α	mΩ	nΗ	10 <sup>-3</sup>	10 <sup>-3</sup>	
$V_{R,70^{\circ}C} = 800 \text{ V DC}, V_{op.85^{\circ}C} = 700 \text{ V DC}$									
6.8	$24.0 \times 15.0 \times 41.5$	_	B32776T8685+000	6.0	22.1	18.0	1.7	15.1	1040
8.5	$24.0 \times 19.0 \times 41.5$	_	B32776T8855+000	7.5	17.8	18.0	1.7	15.1	780
14	$18.0 \times 32.5 \times 41.5$	_	B32776E8146+000	10.0	11.5	23.0	1.8	16.3	720
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G8156+000	12.0	9.6	10.0	1.7	15.2	640
15	$20.0\times39.5\times41.5$	_	B32776E8156+000	11.5	10.3	24.0	1.7	15.7	640
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G8206+000	14.5	7.5	10.0	1.7	15.3	440
20	$28.0\times37.0\times42.0$	_	B32776E8206+000	14.5	7.8	24.0	1.7	15.9	440
20	$43.0 \times 22.0 \times 41.5$	20.3	B32776T8206K000	14.5	7.2	14.0	1.7	15.1	280
22	$28.0\times37.0\times42.0$	10.2	B32776G8226+000	15.5	6.8	11.0	1.7	15.3	440
22	$28.0 \times 37.0 \times 42.0$	_	B32776E8226+000	15.0	7.1	25.0	1.7	16.0	440
25	$28.0 \times 42.5 \times 41.5$	10.2	B32776G8256+000	17.0	6.1	11.0	1.7	15.4	440
25	$28.0 \times 42.5 \times 41.5$	_	B32776E8256+000	16.5	6.4	28.0	1.8	16.3	440
30	$30.0 \times 45.0 \times 42.0$	20.3	B32776G8306+000	19.5	5.1	12.0	1.7	15.6	400
30	$30.0 \times 45.0 \times 42.0$	_	B32776E8306+000	19.0	5.5	30.0	1.8	16.7	400
35	$33.0\times48.0\times42.0$	20.3	B32776G8356+000	22.0	4.3	14.0	1.7	15.7	180
$V_{R,70}$	°C = 900 V DC, V <sub>op</sub>	<sub>85</sub> °C =	800 V DC						
5	$24.0 \times 15.0 \times 41.5$	_	B32776T9505+000	5.5	26.1	19.0	1.5	13.4	1040
7.5	$24.0 \times 19.0 \times 41.5$	_	B32776T9755K000	7.5	17.8	18.0	1.5	13.5	780
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G9156K000	12.5	9.1	12.0	1.5	13.6	640
15	$20.0 \times 39.5 \times 41.5$	_	B32776E9156K000	12.0	9.4	28.0	1.5	14.1	640
16	$43.0 \times 22.0 \times 41.5$	20.3	B32776T9166K000	14.0	8.1	14.0	1.5	13.5	280
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G9206K000	15.0	7.0	11.0	1.5	13.6	440
20	$28.0\times37.0\times42.0$	_	B32776E9206K000	15.0	7.3	26.0	1.6	14.2	440
22	$28.0 \times 42.5 \times 41.5$	10.2	B32776G9226K000	17.0	6.3	12.0	1.5	13.7	440
22	$28.0 \times 42.5 \times 41.5$	_	B32776E9226K000	16.5	6.6	29.0	1.6	14.5	440
25	$30.0 \times 45.0 \times 42.0$	20.3	B32776G9256+000	19.0	5.5	13.0	1.5	13.8	400
25	$30.0 \times 45.0 \times 42.0$	_	B32776E9256+000	18.5	5.9	32.0	1.6	14.7	400
30	$33.0\times48.0\times42.0$	20.3	B32776G9306+000	21.5	4.7	14.0	1.5	13.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$  $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub> at 70 °C, 10 kHz for  $\Delta T \le 20$  °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)





## MKP DC link – high density series – up to 480 $\mu\text{F}$

#### Ordering codes and packing units (lead spacing 37.5 mm)

C <sub>R</sub> <sup>1)</sup>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	ESR <sub>typ</sub>	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	pcs.
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			MOQ
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
μF	mm	mm	,	Α	mΩ	nΗ	10 <sup>-3</sup>	10 <sup>-3</sup>	
$\overline{V_{R.70}}$	<sub>°C</sub> = 1100 V DC, V <sub>op</sub>	<sub>85</sub> ° <sub>C</sub> =	920 V DC						
	24.0 × 15.0 × 41.5	_	B32776T0395+000	5.0	30.5	18.0	1.4	12.1	1040
5	$24.0 \times 19.0 \times 41.5$	_	B32776T0505+000	6.5	23.6	18.0	1.4	12.1	780
12	$20.0 \times 39.5 \times 41.5$	10.2	B32776G0126+000	12.0	10.2	12.0	1.4	12.2	640
12	$20.0 \times 39.5 \times 41.5$	_	B32776E0126+000	11.5	10.5	28.0	1.4	12.6	640
13	$43.0 \times 22.0 \times 41.5$	20.3	B32776T0136K000	13.0	8.9	14.0	1.4	12.1	280
14	$28.0 \times 37.0 \times 42.0$	10.2	B32776G0146+000	13.5	8.7	21.0	1.4	12.2	440
14	$28.0 \times 37.0 \times 42.0$	_	B32776E0146+000	13.5	9.0	25.0	1.4	12.6	440
16	$28.0 \times 42.5 \times 41.5$	10.2	B32776G0166+000	15.5	7.4	12.0	1.4	12.3	440
16	$28.0 \times 42.5 \times 41.5$	_	B32776E0166+000	15.0	7.8	30.0	1.4	12.9	440
20	$30.0 \times 45.0 \times 42.0$	20.3	B32776G0206+000	18.0	6.0	14.0	1.4	12.4	400
20	$30.0 \times 45.0 \times 42.0$	_	B32776E0206+000	17.5	6.5	32.0	1.4	13.1	400
22	$33.0 \times 48.0 \times 42.0$	20.3	B32776G0226+000	21.0	4.9	15.0	1.3	11.4	180
V <sub>R,70</sub>	<sub>°C</sub> = 1300 V DC, V <sub>op</sub>	<sub>85</sub> ° <sub>C</sub> =	1100 V DC						
2.7	$24.0 \times 15.0 \times 41.5$	_	B32776T1275+000	5.0	34.7	19.0	1.1	9.6	1040
3.5	$24.0 \times 19.0 \times 41.5$	_	B32776T1355+000	6.0	27.4	18.0	1.1	9.7	780
8.0	$20.0 \times 39.5 \times 41.5$	10.2	B32776G1805+000	11.0	12.1	12.0	1.1	9.7	640
8.0	$20.0 \times 39.5 \times 41.5$	_	B32776E1805+000	10.5	12.4	24.0	1.2	10.0	640
9.0	$43.0 \times 22.0 \times 41.5$	20.3	B32776T1905K000	12.0	10.7	13.0	1.1	9.7	280
10	$28.0 \times 37.0 \times 42.0$	10.2	B32776G1106+000	13.0	9.6	11.0	1.1	9.7	440
10	$28.0 \times 37.0 \times 42.0$	_	B32776E1106+000	12.5	9.9	26.0	1.2	10.0	440
12	$28.0 \times 42.5 \times 41.5$	10.2	B32776G1126+000	14.5	8.1	12.0	1.1	9.8	440
12	$28.0 \times 42.5 \times 41.5$	_	B32776E1126+000	14.0	8.5	28.0	1.2	10.1	440
14	$30.0 \times 45.0 \times 42.0$	20.3	B32776G1146+000	17.0	6.8	14.0	1.1	10.1	400
14	$30.0 \times 45.0 \times 42.0$	_	B32776E1146+000	16.5	7.3	32.0	1.2	10.4	400
16	$33.0\times48.0\times42.0$	20.3	B32776G1166+000	19.0	6.0	15.0	1.1	9.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ 

 $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub> at 70 °C, 10 kHz for  $\Delta T \le 20$  °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



## MKP DC link – high density series – up to 480 $\mu\text{F}$



#### Ordering codes and packing units (lead spacing 52.5 mm, $P_1$ = 20.3 mm)

C <sub>R</sub> <sup>1)</sup>	Max. dimensions	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	ESR <sub>typ</sub>	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	pcs.
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C			MOQ
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
μF	mm		Α	mΩ	nΗ	10 <sup>-3</sup>	10 <sup>-3</sup>	
V <sub>R,70</sub>	$v_{\rm C} = 450 \text{ V DC}, V_{\rm op,85}$	<sub>°C</sub> = 450 V DC						
55	$43.0 \times 24.0 \times 57.5$	B32778T4556K000	16.5	7.2	13.0	4.3	41.7	420
75	$30.0 \times 45.0 \times 57.5$	B32778G4756+000	21.0	5.6	12.0	4.4	42.6	280
80	$30.0 \times 45.0 \times 57.5$	B32778G4806+000	21.5	5.3	13.0	4.4	42.7	280
100	$35.0 \times 50.0 \times 57.5$	B32778G4107+000	26.0	4.3	14.0	4.5	43.3	108
110	$35.0\times50.0\times57.5$	B32778G4117K000	27.0	3.9	15.0	4.5	43.6	108
150	$130.0 \times 24.0 \times 57.5$	B32778J4157K000	43.5	2.7	4.0	4.4	42.1	80
170	$45.0 \times 57.0 \times 57.5$	B32778G4177+000	36.5	2.6	17.0	4.6	45.7	140
180	$60.0 \times 45.0 \times 57.5$	B32778G4187+000	39.0	2.5	19.0	4.6	44.6	200
480	$130.0 \times 58.0 \times 57.5$	B32778J4487K000	79.5	0.9	6.0	4.8	45.4	40
V <sub>R,70</sub>	$v_{\rm C} = 575 \text{ V DC}, V_{\rm op,85}$	°c = 500 V DC						
40	$43.0 \times 24.0 \times 57.5$	B32778T5406K000	15.5	8.5	13.0	3.6	34.5	420
60	$30.0 \times 45.0 \times 57.5$	B32778G5606+000	20.5	5.8	13.0	3.7	35.3	280
80	$35.0\times50.0\times57.5$	B32778G5806+000	25.5	4.4	15.0	3.7	36.0	108
110	$130.0\times24.0\times57.5$	B32778J5117K000	40.5	3.0	5.0	3.6	34.5	80
120	$45.0\times57.0\times57.5$	B32778G5127+000	34.5	3.1	17.0	3.8	37.2	140
130	$60.0 \times 45.0 \times 57.5$	B32778G5137+000	36.5	2.8	19.0	3.8	36.7	200
360	$130.0\times58.0\times57.5$	B32778J5367K000	75.0	1.0	6.0	4.0	37.3	40
$V_{R,70}$	$_{\rm C} = 800 \text{ V DC}, V_{\rm op,85}$	°c = 700 V DC						
30	$43.0\times24.0\times57.5$	B32778T8306K000	14.5	9.8	14.0	3.2	30.2	420
45	$30.0\times45.0\times57.5$	B32778G8456+000	19.5	6.6	14.0	3.2	30.9	280
50	$30.0\times45.0\times57.5$	B32778G8506+000	20.0	6.3	13.0	3.2	30.9	280
55	$35.0\times50.0\times57.5$	B32778G8556+000	23.0	5.6	14.0	3.2	31.1	108
60	$35.0\times50.0\times57.5$	B32778G8606+000	23.5	5.1	15.0	3.3	31.2	108
80	$130.0\times24.0\times57.5$	B32778J8806K000	37.5	3.6	4.0	3.2	30.2	80
90	$45.0\times57.0\times57.5$	B32778G8906+000	32.5	3.5	17.0	3.3	32.2	140
100	$60.0\times45.0\times57.5$	B32778G8107+000	34.5	3.2	19.0	3.3	31.9	200
270	$130.0\times58.0\times57.5$	B32778J8277K000	70.5	1.2	6.0	3.5	32.4	40

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$  $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub> at 70 °C, 10 kHz for  $\Delta T \le$  20 °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)





## MKP DC link – high density series – up to 480 $\mu\text{F}$

#### Ordering codes and packing units (lead spacing 52.5 mm, $P_1$ = 20.3 mm)

C <sub>R</sub> <sup>1)</sup>	Max. dimensions	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	$ESR_{typ}$	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	pcs.
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C			MOQ
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	
μF	mm		Α	mΩ	nΗ	10 <sup>-3</sup>	10 <sup>-3</sup>	
V <sub>R,70 °C</sub> = 900 V DC, V <sub>op,85 °C</sub> = 800 V DC								
25	$43.0 \times 24.0 \times 57.5$	B32778T9256K000	13.5	10.7	13.0	2.8	26.8	420
35	$30.0 \times 45.0 \times 57.5$	B32778G9356+000	18.0	7.7	13.0	2.9	27.3	280
50	$35.0\times50.0\times57.5$	B32778G9506K000	22.5	5.6	15.0	2.9	27.7	108
70	$45.0 \times 57.0 \times 57.5$	B32778G9706+000	31.0	3.8	18.0	3.0	28.5	140
70	$130.0 \times 24.0 \times 57.5$	B32778J9706K000	36.0	3.8	4.0	2.9	27.2	80
75	$60.0 \times 45.0 \times 57.5$	B32778G9756+000	32.5	3.6	20.0	2.9	28.2	200
210	$130.0 \times 58.0 \times 57.5$	B32778J9217K000	66.0	1.3	6.0	3.1	28.6	40
V <sub>R,70</sub>	<sub>C</sub> = 1100 V DC, V <sub>op,85</sub>	<sub>°C</sub> = 920 V DC						
20	$43.0 \times 24.0 \times 57.5$	B32778T0206K000	13.0	11.9	13.0	2.6	24.1	420
30	$30.0 \times 45.0 \times 57.5$	B32778G0306+000	17.5	8.2	13.0	2.6	24.5	280
40	$35.0\times50.0\times57.5$	B32778G0406+000	21.5	6.2	15.0	2.7	25.9	108
58	$45.0 \times 57.0 \times 57.5$	B32778G0586+000	29.0	4.3	17.0	2.7	25.4	140
60	$60.0 \times 45.0 \times 57.5$	B32778G0606+000	30.5	4.0	19.0	2.7	25.2	200
60	$130.0 \times 24.0 \times 57.5$	B32778J0606K000	34.5	4.1	4.0	2.7	25.1	80
200	$130.0 \times 58.0 \times 57.5$	B32778J0207K000	66.0	1.4	6.0	3.0	26.8	40
V <sub>R,70</sub>	<sub>C</sub> = 1300 V DC, V <sub>op,85</sub>	°c = 1100 V DC						
14	$43.0 \times 24.0 \times 57.5$	B32778T1146K000	12.0	13.8	13.0	2.1	19.5	420
20	$30.0 \times 45.0 \times 57.5$	B32778G1206+000	16.0	9.7	13.0	2.1	19.8	280
25	$35.0\times50.0\times57.5$	B32778G1256+000	19.0	7.8	15.0	2.1	19.9	108
27	$35.0 \times 50.0 \times 57.5$	B32778G1276+000	19.5	7.3	15.0	2.1	20.0	108
38	$130.0 \times 24.0 \times 57.5$	B32778J1386K000	31.5	5.1	4.0	2.1	19.5	80
40	$45.0 \times 57.0 \times 57.5$	B32778G1406+000	26.5	5.0	17.0	2.2	20.3	140
42	$60.0 \times 45.0 \times 57.5$	B32778G1426+000	28.0	4.7	19.0	2.2	20.2	200
120	$130.0\times58.0\times57.5$	B32778J1127K000	58.5	1.7	6.0	2.3	20.5	40

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

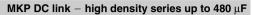
 $J = \pm 5\%$  $K = \pm 10\%$ 

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub> at 70 °C, 10 kHz for  $\Delta T \le 20$  °C at  $\Delta ESR_{typ} \le \pm 5\%$ 

<sup>3)</sup> Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)







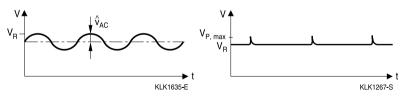
#### Technical data

Reference standard: IEC 61071.

All data given at T = 20  $^{\circ}$ C, unless otherwise specified.

All data giver at 1 =	20 0, 0111035 0111011	vioc opcoi	nou.					
Operating temperature range (case)		Max. operating temperature, T <sub>op,max</sub> +105 °C					;	
		Upper ca	ategory te	mperature	e T <sub>max</sub>	+105 °C	)	
		Lower ca	ategory te	mperature	e T <sub>min</sub>	–40 °C	)	
Insulation Resistanc	e R <sub>ins</sub>	$\tau > 10.00$	00 s (aftei	r 1 min.)				
given as time consta	ınt	For V <sub>B</sub> ≥ 500 V measured at 500 V						
$\tau = C_R \cdot R_{ins}$ , rel. hun	nidity ≤ 65%	For V <sub>R</sub> <	500 V m	easured a	t V <sub>R</sub>			
(minimum as-deliver	ed values)							
DC test voltage betw	veen terminals (10 s)	1.5 · V <sub>R</sub>						
Voltage test termina	I to case (10 s)	2110 V AC, 50 Hz						
Pulse Handling Capa	ability (V/µs)	I <sub>P</sub> (A) / C (μF)						
Reliability: Failure rate λ		10 fit ( $\leq 1 \cdot 10^{-9}$ /h) at 0.5 · V <sub>R</sub> , 40 °C						
•		For conversion to other operating conditions and						
		temperatures, refer to chapter "Quality, 2 Reliability".						
	Service life t <sub>SL</sub>		100 000 h at V <sub>R</sub> and 70 °C					
	V <sub>R</sub> (V DC)	450	575	800	900	1100	1300	
Continuous operation voltage		450	575	800	900	1100	1300	
$V_{op}$ (V DC) at 70 °C								
Continuous operation voltage		450	500	700	800	920	1100	
$V_{op}$ (V DC) at 85 °C								
For temperatures be	1.33%/°C of V <sub>oo</sub> derating compared to V <sub>oo</sub> at 85 °C							
85 °C and 105 °C				Ü	•	- r		
		•						

## **Typical waveforms**



#### Restrictions:

 $V_R$ : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\hat{\textbf{v}}_{\text{AC}}\!\leq \textbf{0.2}\,\cdot\,\textbf{V}_{\text{R}}$ 





#### MKP DC link – high density series up to 480 $\mu$ F

Overvoltage	Maximum duration within one day	Observation		
1.1 · V <sub>R</sub>	30% of on-load duration	System regulation		
1.15 ⋅ V <sub>R</sub>	30 min.	System regulation		
$1.2 \cdot V_R$	5 min.	System regulation		
1.3 · V <sub>R</sub>	1 min.	System regulation		

NOTE 1 An overvoltage equal to  $1.5 \cdot V_R$  for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

#### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/us.

#### Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

#### dV/dt values

Lead spacing	27.5 mm			37.5 mm						
Туре	B32774			B32776						
V <sub>R</sub> (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
dV/dt in V/μs	30	40	75	100	21	22	22	35	54	73

Lead spacing	52.5 mm						
Туре	B3277	8					
V <sub>R</sub> (V DC)	450	575	800	900	1100	1300	
dV/dt in V/μs	14	14	15	22	35	50	



# MKP DC link - high density series - up to 480 $\mu\text{F}$



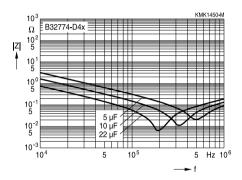
#### Characteristics curves

Additional technical information can be found under "Design support" on www.epcos.com

# Impedance Z versus frequency f

(typical values)

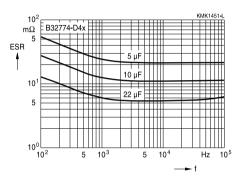
Lead spacing 27.5 mm / B32774D4\*



# ESR versus frequency f

(typical values)

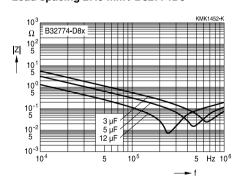
Lead spacing 27.5 mm / B32774D4\*



# Impedance Z versus frequency f

(typical values)

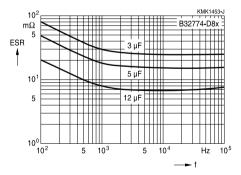
#### Lead spacing 27.5 mm / B32774D8\*



# ESR versus frequency f

(typical values)

#### Lead spacing 27.5 mm / B32774D8\*





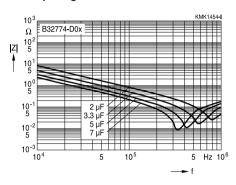


## MKP DC link - high density series - up to 480 $\mu\text{F}$

#### Characteristics curves

# Impedance Z versus frequency f (typical values)

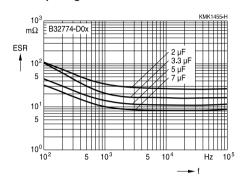
#### Lead spacing 27.5 mm / B32774D0\*



# ESR versus frequency f

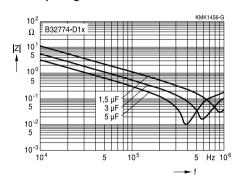
(typical values)

#### Lead spacing 27.5 mm / B32774D0\*



# Impedance Z versus frequency f (typical values)

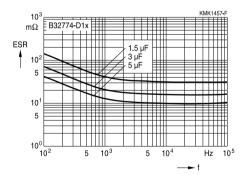
# Lead spacing 27.5 mm / B32774D1\*



# ESR versus frequency f

(typical values)

## Lead spacing 27.5 mm / B32774D1\*





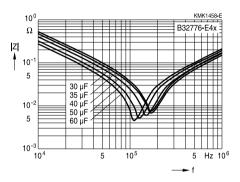
# MKP DC link - high density series - up to 480 $\mu\text{F}$



#### Characteristics curves

# Impedance Z versus frequency f (typical values)

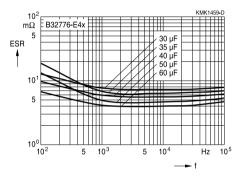
## Lead spacing 37.5 mm / B32776-E4x



# ESR versus frequency f

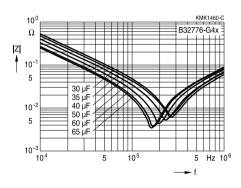
(typical values)

# Lead spacing 37.5 mm / B32776-E4x



# Impedance Z versus frequency f (typical values)

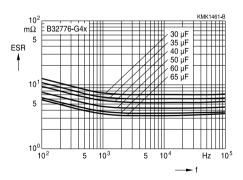
#### Lead spacing 37.5 mm / B32776-G4x



# ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-G4x







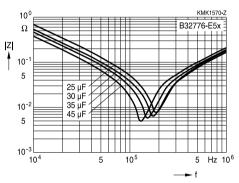
#### MKP DC link – high density series – up to 480 $\mu$ F

#### Characteristics curves

## Impedance Z versus frequency f

(typical values)

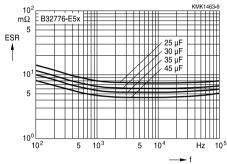
Lead spacing 37.5 mm / B32776-E5x



## ESR versus frequency f

(typical values)

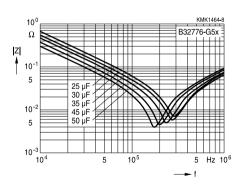
Lead spacing 37.5 mm / B32776-E5x



# Impedance Z versus frequency f

(typical values)

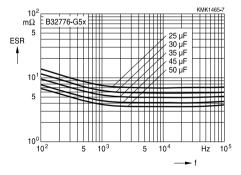
#### Lead spacing 37.5 mm / B32776-G5x



## ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-G5x





# MKP DC link - high density series - up to 480 $\mu\text{F}$

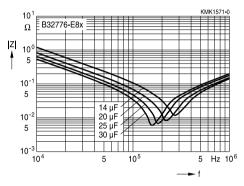


#### Characteristics curves

# Impedance Z versus frequency f

(typical values)

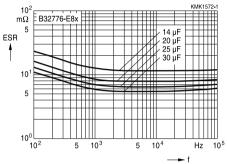
# Lead spacing 37.5 mm / B32776-E8x



#### ESR versus frequency f

(typical values)

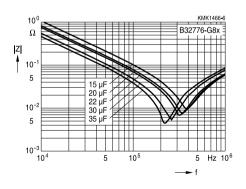
# Lead spacing 37.5 mm / B32776-E8x



# Impedance Z versus frequency f

(typical values)

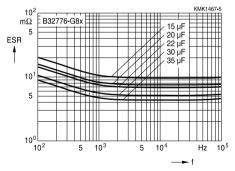
#### Lead spacing 37.5 mm / B32776-G8x



#### ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-G8x







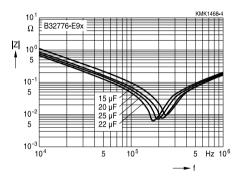
#### MKP DC link – high density series – up to 480 $\mu\text{F}$

#### Characteristics curves

# Impedance Z versus frequency f

(typical values)

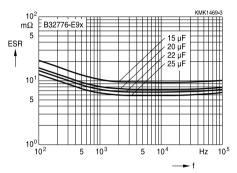
# Lead spacing 37.5 mm / B32776-E9x



## ESR versus frequency f

(typical values)

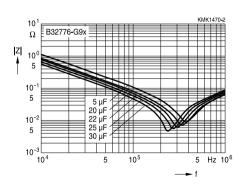
## Lead spacing 37.5 mm / B32776-E9x



# Impedance Z versus frequency f

(typical values)

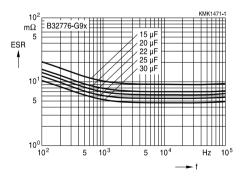
#### Lead spacing 37.5 mm / B32776-G9x



# ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-G9x





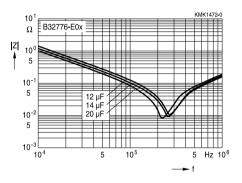
# MKP DC link - high density series - up to 480 $\mu\text{F}$



#### Characteristics curves

# Impedance Z versus frequency f (typical values)

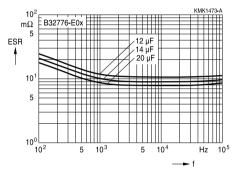
# Lead spacing 37.5 mm / B32776-E0x



# ESR versus frequency f

(typical values)

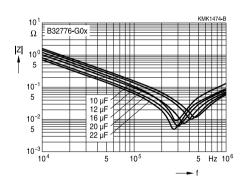
# Lead spacing 37.5 mm / B32776-E0x



# Impedance Z versus frequency f

(typical values)

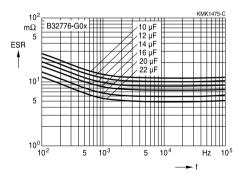
#### Lead spacing 37.5 mm / B32776-G0x



# ESR versus frequency f

(typical values)

## Lead spacing 37.5 mm / B32776-G0x





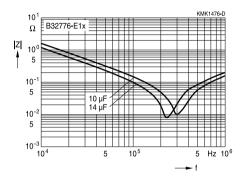


#### MKP DC link – high density series – up to 480 $\mu\text{F}$

#### Characteristics curves

# Impedance Z versus frequency f (typical values)

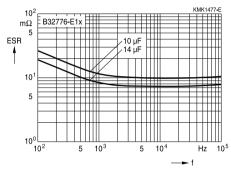
Lead spacing 37.5 mm / B32776-E1x



#### ESR versus frequency f

(typical values)

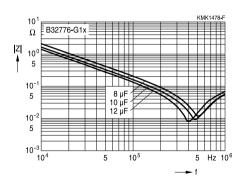
Lead spacing 37.5 mm / B32776-E1x



# Impedance Z versus frequency f

(typical values)

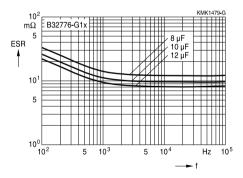
#### Lead spacing 37.5 mm / B32776-G1x



# ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-G1x





# MKP DC link - high density series - up to 480 $\mu\text{F}$

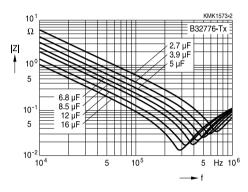


#### Characteristics curves

# Impedance Z versus frequency f

(typical values)

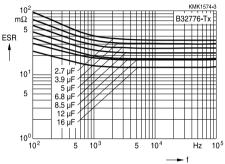
Lead spacing 37.5 mm / B32776-Tx / 2-pins



## ESR versus frequency f

(typical values)

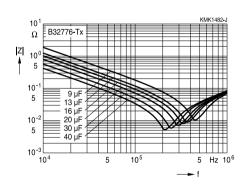
Lead spacing 37.5 mm / B32776-Tx / 2-pins



# Impedance Z versus frequency f

(typical values)

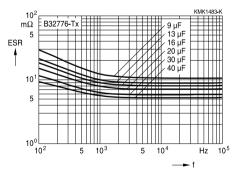
Lead spacing 37.5 mm / B32776-Tx / 4-pins



# ESR versus frequency f

(typical values)

#### Lead spacing 37.5 mm / B32776-Tx / 4-pins







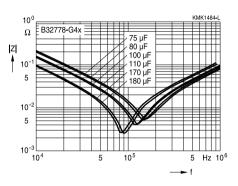
## MKP DC link - high density series - up to 480 $\mu\text{F}$

#### Characteristics curves

# Impedance Z versus frequency f

(typical values)

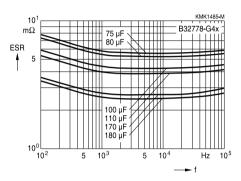
# Lead spacing 52.5 mm / B32778-G4x



## ESR versus frequency f

(typical values)

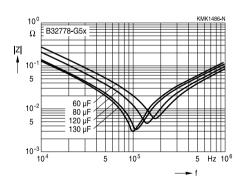
## Lead spacing 52.5 mm / B32778-G4x



# Impedance Z versus frequency f

(typical values)

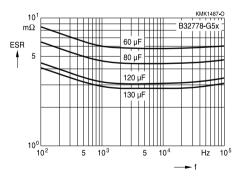
#### Lead spacing 52.5 mm / B32778-G5x



# ESR versus frequency f

(typical values)

#### Lead spacing 52.5 mm / B32778-G5x





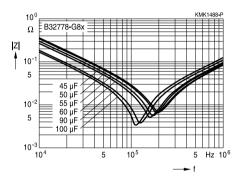
## MKP DC link – high density series – up to 480 $\mu\text{F}$



#### Characteristics curves

# Impedance Z versus frequency f (typical values)

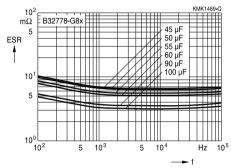
## Lead spacing 52.5 mm / B32778-G8x



# ESR versus frequency f

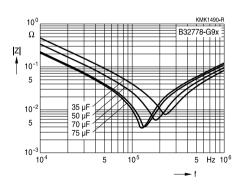
(typical values)

# Lead spacing 52.5 mm / B32778-G8x



# Impedance Z versus frequency f (typical values)

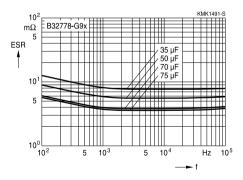
# Lead spacing 52.5 mm / B32778-G9x



# ESR versus frequency f

(typical values)

#### Lead spacing 52.5 mm / B32778-G9x







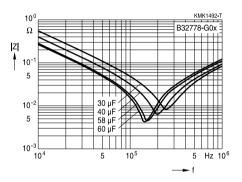
## MKP DC link - high density series - up to 480 $\mu\text{F}$

#### Characteristics curves

# Impedance Z versus frequency f

(typical values)

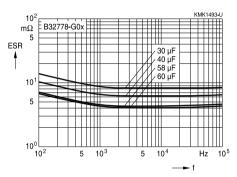
# Lead spacing 52.5 mm / B32778-G0x



#### ESR versus frequency f

(typical values)

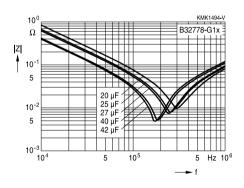
## Lead spacing 52.5 mm / B32778-G0x



# Impedance Z versus frequency f

(typical values)

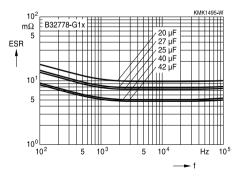
#### Lead spacing 52.5 mm / B32778-G1x



# ESR versus frequency f

(typical values)

#### Lead spacing 52.5 mm / B32778-G1x





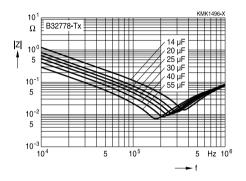
# MKP DC link – high density series – up to 480 $\mu\text{F}$



#### Characteristics curves

# Impedance Z versus frequency f (typical values)

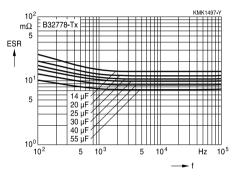
Lead spacing 52.5 mm / B32778-Tx



#### ESR versus frequency f

(typical values)

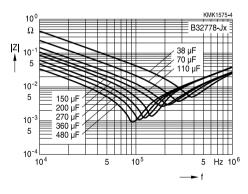
Lead spacing 52.5 mm / B32778-Tx



# Impedance Z versus frequency f

(typical values)

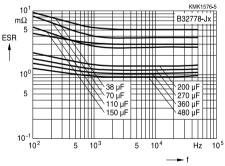
#### Lead spacing 52.5 mm / B32778-Jx



# ESR versus frequency f

(typical values)

#### Lead spacing 52.5 mm / B32778-Jx







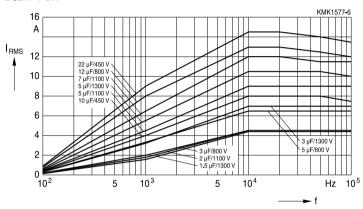
## MKP DC link - high density series - up to 480 $\mu\text{F}$

#### Characteristics curves

# Permissible current I<sub>RMS</sub> versus frequency f at 70 °C

## Lead spacing 27.5 mm

## B32774-Dx





# MKP DC link - high density series - up to 480 $\mu\text{F}$

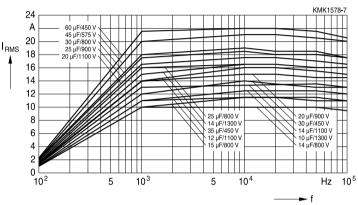


#### Characteristics curves

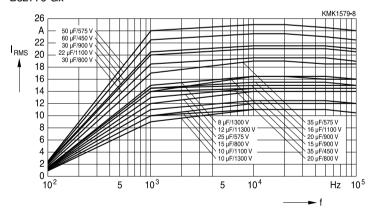
## Permissible current I<sub>RMS</sub> versus frequency f at 70 °C

#### Lead spacing 37.5 mm

# B32776-Ex



#### B32776-Gx







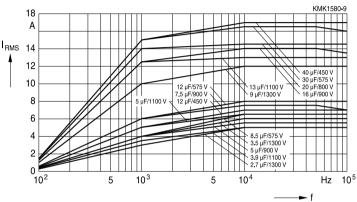
MKP DC link - high density series - up to 480  $\mu\text{F}$ 

#### Characteristics curves

# Permissible current $I_{\text{RMS}}$ versus frequency f at 70 $^{\circ}\text{C}$

# Lead spacing 37.5 mm







## MKP DC link – high density series – up to 480 $\mu\text{F}$

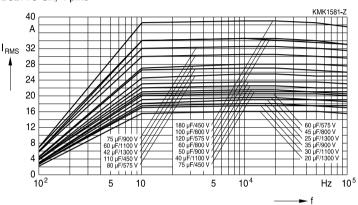


#### Characteristics curves

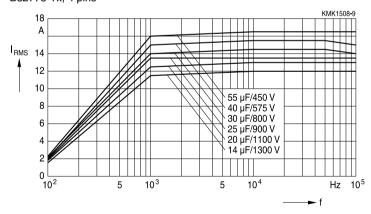
# Permissible current $I_{RMS}$ versus frequency f at 70 $^{\circ}$ C

#### Lead spacing 52.5 mm

## B32778-Gx, 4 pins



#### B32778-Tx, 4 pins







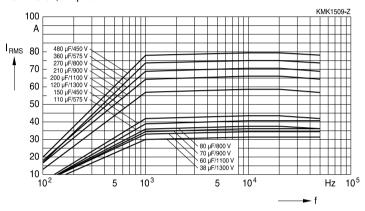
## MKP DC link - high density series - up to 480 $\mu\text{F}$

#### Characteristics curves

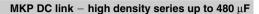
# Permissible current $I_{RMS}$ versus frequency f at 70 $^{\circ}$ C

## Lead spacing 52.5 mm

B32778-Jx, 12 pins

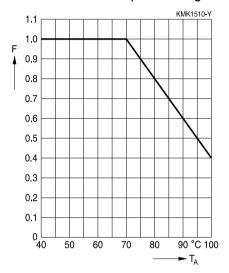








# **Curves Characteristics (Irms derating vs temperature)**



Maximum  $I_{RMS}$  current as function of the ambient temperature:  $I_{RMS}$  ( $T_A$ ) = Factor  $\times$   $I_{RMS}$  (70 °C)





## MKP DC link – high density series up to 480 $\mu\text{F}$

## Heat transference for self heating calculation

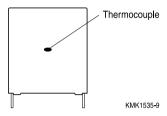
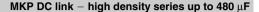


Figure 1

Box dimen	sions	Equivalent heat		
		coefficient		
w (mm)	h (mm)	I (mm)	G (mW/°C)	
11.0	19.0	31.5	25	
11.0	21.0	31.5	28	
12.5	21.5	31.5	30	
13.5	23.0	31.5	32	
14.0	24.5	31.5	35	
15.0	24.5	31.5	36	
16.0	32.0	31.5	45	
18.0	27.5	31.5	44	
18.0	33.0	31.5	48	
19.0	30.0	31.5	48	
20.0	11.0	31.5	65	
21.0	31.0	31.5	51	
22.0	36.5	31.5	58	
12.0	22.0	41.5	70	
14.0	25.0	41.5	43	
16.0	28.5	41.5	50	
18.0	32.5	41.5	59	
20.0	39.5	41.5	72	
24.0	19.0	41.5	50	
24.0	15.0	41.5	44	
28.0	37.0	42.0	83	
28.0	42.5	41.5	90	
30.0	45.0	42.0	100	
33.0	48.0	42.0	100	
43.0	22.0	41.5	80	
30.0	45.0	57.5	125	
35.0	50.0	57.5	145	
43.0	24.0	57.5	103	
45.0	57.0	57.5	185	
60.0	45.0	57.5	192	
130.0	24.0	57.5	200	
130.0	58.0	57.5	300	

The equivalent heat coefficient "G (mW/PC)" is given for measuring the temperature on the lateral surface of the plastic box as figure1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.







#### Self Heating by power dissipation & equivalent heat coefficient

The  $I_{RMS}$  and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of  $\Delta T$  allowed for this series.  $\Delta T_{max}$  given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures  $\Delta T_{max}$  (T) will have the same derating factor than  $I_{RMS}$  vs temperature and then an equivalent derating as per: ambient temperatures  $\Delta T_{max}$  (T) will have the same derating factor than  $I_{RMS}$  vs temperature and then an equivalent derating as per:

$$\Delta T_{\text{max}}$$
 (T) = (Factor)<sup>2</sup> ×  $\Delta T$  (70 °C).

For any particular  $I_{RMS}$  the  $\Delta T$  may be calculated by:

$$\Delta T$$
 (°C) = P<sub>dis</sub> (mW) / G(mW/°C).

Where  $\Delta T$  (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T$$
 (°C) =  $T_{op}$  (°C) -  $T_{A}$  (°C).

It represents the increasing of temperature provoked by the  $I_{RMS}$  during operation. G (mW/°C) is the equivalent heat coefficient described above and  $P_{dis}$  (mW) is the dissipated power defined by:

$$P_{dis}$$
 (mW) = ESR<sub>typ</sub> (m $\Omega$ ) ×  $I_{rms}^2$  (A<sub>RMS</sub>).

#### Example for thermal calculation:

We will take as reference B32778G0306K (30  $\mu$ F/1100 V) type for thermal calculation. Considering the following load and capacitor characteristics:

I<sub>RMS</sub>: 12 A<sub>RMS</sub> at 20 kHz

T<sub>4</sub>: 85 °C

 $30 \times 45 \times 57.5$  box

G (mW/°C): 125

Then we have to find the  $\text{ESR}_{\text{typ}}$  at 20 kHz what is approx . 8.2 m $\!\Omega.$ 

So according to:

$$P_{dis}$$
 (mW) = ESR<sub>tvp</sub> (m $\Omega$ ) ×  $I_{rms}^2$  (A<sub>RMS</sub>)

we have the following:

$$P_{dis}$$
 (mW) = 8.2 m $\Omega \times 12 A_{RMS}^2 = 1181 \text{ mW}$ 

and as per:

$$\Delta T$$
 (°C) =  $P_{dis}$  (mW) / G (mW/°C)

we have the following:

$$\Delta T$$
 (°C) = 1181 (mW) / 125 (mW/°C) = 9.5 °C.

What is below of the

$$\Delta T_{\text{max}}$$
 (85 °C) = (Factor)<sup>2</sup> ×  $\Delta T$  (70 °C) = (0.7)<sup>2</sup> × 20 °C = 9.8 °C.

On the other hand we may confirm that max  $I_{RMS}$  at 20 kHz at 70 °C = 17.5  $A_{RMS}$ 

And then max I<sub>RMS</sub> for 85 °C of ambient temperature is defined as follows:

$$I_{RMS}$$
 (85 °C) = Factor ×  $I_{RMS}$  (70 °C) = 0.7 × 17.5  $A_{RMS}$  = 12.25  $A_{RMS}$ .

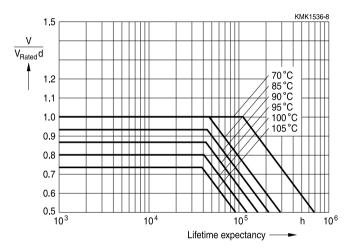
What confirms once again that  $I_{RMS}$  (12  $A_{RMS}$  at 20 kHz) is below the max specified for such frequency and ambient temperature.



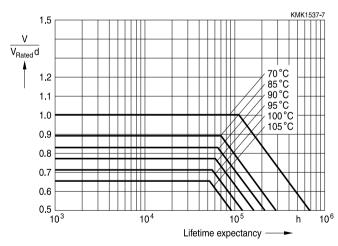


## MKP DC link – high density series up to 480 $\mu\text{F}$

# Life time expectancy - typical curve (450 V DC / B3277x-X4

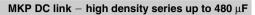


# Life time expectancy - typical curve (575 V DC / 800 V DC / 900 V DC / 1100 V DC / 1300 V DC / B3277X-5/8/9/0/1)



Note: Confidence level of 95%







## **Testing and Standards**

Test	Reference	Conditions of test		Performance requirements
Electrical	IEC 61071-11	Voltage between terminals,		Within specified limits
Parameters		1.5 V <sub>B</sub> , during 10 s		
(Routine test)		Insulation resistance, R <sub>INS</sub> at		
		$V_R$ if $V_R < 500$ V or		
		500 V if V <sub>R</sub> ≥ 500 V		
		Capacitance, C at 1	kHz	
		(room temperature)		
		Dissipation factor, t	an $\delta$ at	
		1/10 kHz (room temperature)		
Robustness	IEC 60068-2-21	Tensile strength (te	st Ua1)	Capacitance and tan δ
of termina-			Tensile	within specified limits
tions		Wire diameter	force	
(Type test)		$0.5 < d_1 \le 0.8 \text{ mm}$	10 N	
		$0.8 < d_1 \le 1.25 \text{ mm}$	20 N	
Resistance to	IEC 60068-2-20,	Solder bath temper	ature at	$\Delta C/C_0 \le 2\%$
soldering	test Tb,	260 ± 5 °C, immers	ion for	$ \Delta \tan \delta  \le 0.002$
heat	method 1A	10 seconds		
(Type test)				
Rapid	IEC 60384-16	T <sub>A</sub> = lower category	temperature	$ \Delta C/C_0  \le 2\%$
change of		T <sub>B</sub> = upper category	•	$ \Delta \tan \delta  \le 0.002$
temperature		Five cycles, duration t = 30 min.		R <sub>INS</sub> ≥ 50% of initial limit
(Type test)				
Vibration	IEC 60384-16	Test F <sub>c</sub> : vibration sinusoidal		No visible damage
(Type test)		Displacement: 0.75 mm		
		Accleration: 98 m/s	2	
		Frequency: 10 Hz .	500 Hz	
		Test duration: 3 ortl	nogonal axes,	
		2 hours each axe		
Bump	IEC 60384-16	Test Eb: Total 400	0 bumps with	No visible damage
(Type test)		390 m/s <sup>2</sup> mounted of	on PCB	$ \Delta C/C_0  \le 2\%$
		6 ms duration		$I\Delta \tan \delta I \le 0.002$
				R <sub>INS</sub> ≥ 50% of initial limit
Climatic	IEC 60384-16	Dry heat Tb / 16 h.		No visible damage
sequence		Damp heat cyclic, 1st cycle		$ \Delta C/C_0  \le 3\%$
(Type test)	·		100% RH	l∆ tan δl ≤ 0.001
		Cold Ta / 2h		$R_{INS} \ge 50\%$ of initial limit
		Damp heat cyclic, 5 cycles		
		+ 55 °C / 24h / 95% 100% RH		





#### MKP DC link – high density series up to 480 $\mu$ F

Test	Reference	Conditions of test	Performance requirements
Damp Heat	IEC 60384-16	Test Ca	No visible damage
Steady State		40 °C / 93% RH / 56 days	$ \Delta C/C_0  \le 5\%$
(Type test)			I∆ tan δl ≤ 0.005
, ,,			R <sub>INS</sub> ≥ 50% of initial limit
Endurance	IEC 60384-16	70 °C / 1.25 V <sub>R</sub> / 1000 hours or	No visible damage
(Type test)		85 °C / 1.25 V <sub>op</sub> / 1000 hours or	$ \Delta C/C_0  \le 5\%$ at 1 kHz
		100 °C / 1.25 V <sub>op</sub> / 1000 hours	$ \Delta \tan \delta  \le 0.005$
			R <sub>INS</sub> ≥ 50% of initial limit

## Mounting guidelines

## 1 Soldering

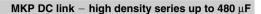
### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



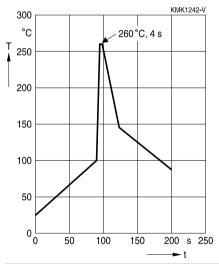




## 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series		Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated	260 ±5 °C	10 ±1 s
	uncoated (lead spacing > 10 mm)		
MFP			
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤ 7.5 mm)		< 4 s
MKT	uncoated (lead spacing ≤ 10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 $\pm 0.5)$ mm thick, between capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors	
$tan  \delta$	As specified in sectional specification	





#### MKP DC link – high density series up to 480 $\mu$ F

## 1.3 General notes on soldering

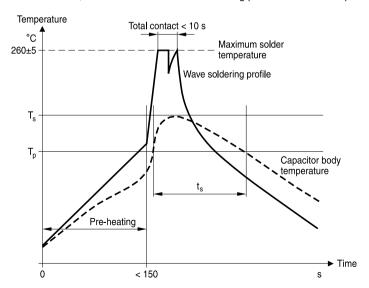
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{\text{max}}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

#### **EPCOS** recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

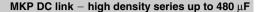


T<sub>s</sub>: Capacitor body maximum temperature at wave soldering

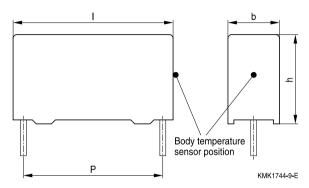
KMK1745-A-E

T<sub>n</sub>: Capacitor body maximum temperature at pre-heating









Body temperature should follow the description below:

■ MKP capacitor

During pre-heating:  $T_p \le 110 \, ^{\circ}\text{C}$ During soldering:  $T_s \le 120 \, ^{\circ}\text{C}$ ,  $t_s \le 45 \, \text{s}$ 

■ MKT capacitor

During pre-heating:  $T_p \le 125$  °C During soldering:  $T_s \le 160$  °C,  $t_s \le 45$  s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor ( $T_s$ ) must be  $\leq$  120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be < 360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.





#### MKP DC link – high density series up to 480 $\mu$ F

#### Cautions and warnings

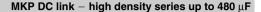
- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the specified	4.5
conditions	range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive	5.3
	flammability), avoid overload of the capacitors (active	"Flammability"
	flammability) and consider the flammability of materials.	
Resistance to	Do not exceed the tested ability to withstand vibration.	5.2
vibration	The capacitors are tested to IEC 60068-2-6.	"Resistance to
	EPCOS offers film capacitors specially designed for	vibration"
	operation under more severe vibration regimes such as	
	those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account.	3 "Embedding of capacitors in finished assemblies"
assemblies	Caution: Consult us first, if you also wish to embed other uncoated component types!	







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# MKP DC link – high density series up to 480 $\mu\text{F}$

## Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$lpha_{ extsf{C}}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
$\beta_{C}$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
ΔV/Δt	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
	Fragues Visit for radicing permissible	Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen
	Ao voltage due to current innit	Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
F <sub>D</sub>	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
. ט		Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I <sub>C</sub>	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





# MKP DC link - high density series up to 480 $\mu\text{F}$

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
İz	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
$\lambda_{o}$	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{\text{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R <sub>i</sub>	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R <sub>P</sub>	Parallel resistance	Parallelwiderstand
R <sub>s</sub>	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan $\delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T <sub>A</sub>	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>OL</sub>	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T <sub>op</sub>	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer





# MKP DC link - high density series up to 480 $\mu\text{F}$

Symbol	English	German
V <sub>AC</sub>	AC voltage	Wechselspannung
$V_{c}$	Category voltage	Kategoriespannung
$V_{\text{C,RMS}}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_{i}$	Input voltage	Eingangsspannung
$V_{\circ}$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
Ŷ <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
$V_{\text{SC}}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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